National Semiconductor

February 1988

CD4541BM/CD4541BC Programmable Timer

General Description

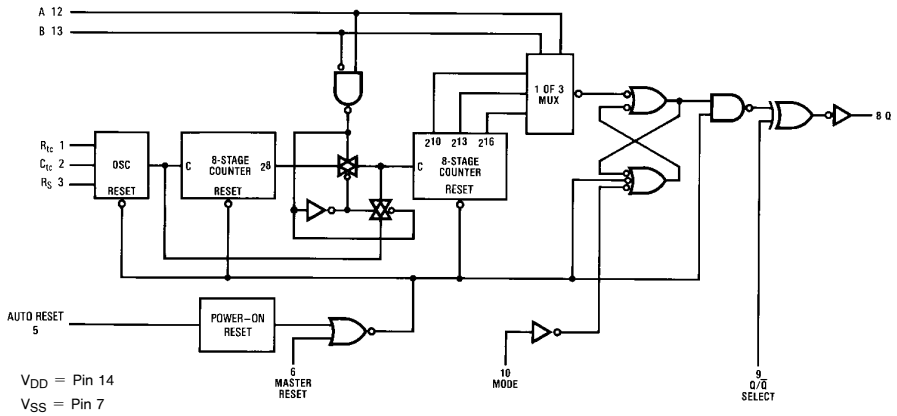
The CD4541B Programmable Timer is designed with a 16-stage binary counter, an integrated oscillator for use with an external capacitor and two resistors, output control logic, and a special power-on reset circuit. The special features of the power-on reset circuit are first, no additional static power consumption and second, the part functions across the full voltage range (3V–15V) whether power-on reset is enabled or disabled.

Timing and the counter are initialized by turning on power, if the power-on reset is enabled. When the power is already on, an external reset pulse will also initialize the timing and counter. After either reset is accomplished, the oscillator frequency is determined by the external RC network. The 16-stage counter divides the oscillator frequency by any of 4 digitally controlled division ratios.

Features

- Available division ratios 2^8, 2^{10}, 2^{13}, or 2^{16}
- Increments on positive edge clock transitions
- Built-in low power RC oscillator (±2% accuracy over temperature range and ±10% supply and ±3% over processing @ < 10 kHz)
- Oscillator frequency range ≈ DC to 100 kHz
- Oscillator may be bypassed if external clock is available (apply external clock to pin 3)
- Automatic reset initializes all counters when power turns on
- External master reset totally independent of automatic reset operation
- Operates at 2^n frequency divider or single transition timer
- Q/$\overline{Q}$ select provides output logic level flexibility
- Reset (auto or master) disables oscillator during resetting to provide no active power dissipation
- Clock conditioning circuit permits operation with very slow clock rise and fall times
- Wide supply voltage range—3.0V to 15V
- High noise immunity—0.45 V_{DD} (typ.)
- 5V–10V–15V parameter ratings
- Symmetrical output characteristics
- Maximum input leakage 1 μA at 15V over full temperature range
- High output drive (pin 8) min. one TTL load

Logic Diagram



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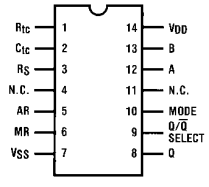
Connection Diagram

Dual-In-Line Package



N.C.—Not connected

TL/F/6001–2

Top View

Order Number CD4541B

RRD-B30M105/Printed in U. S. A.

Absolute Maximum Ratings (Notes 1 & 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (V_{DD})	−0.5V to +18V
Input Voltage (V_{IN})	−0.5V to V_{DD} +0.5V
Storage Temperature Range (T_S)	−65°C to +150°C
Power Dissipation (P_D)	
Dual-In-Line	700 mW
Small Outline	500 mW
Lead Temperature (T_L) (soldering, 10 sec.)	260°C

Recommended Operating Conditions (Note 2)

Supply Voltage (V_{DD})	3V to 15V
Input Voltage (V_{IN})	0 to V_{DD}
Operating Temperature Range	
CD4541BM	−55°C to +125°C
CD4541BC	−40°C to +85°C

DC Electrical Characteristics (Note 2)—CD4541BM

Symbol	Parameter	Conditions	−55°C		+25°C			+125°C		Units
			Min	Max	Min	Typ	Max	Min	Max	
I_{DD}	Quiescent Device Current	V_{DD} = 5V, V_{IN} = V_{DD} or V_{SS}		5		0.005	5		150	μA
		V_{DD} = 10V, V_{IN} = V_{DD} or V_{SS}		10		0.010	10		300	μA
		V_{DD} = 15V, V_{IN} = V_{DD} or V_{SS}		20		0.015	20		600	μA
V_{OL}	Low Level Output Voltage	V_{DD} = 5V		0.05		0	0.05		0.05	V
		V_{DD} = 10V $\|I_O\| < 1$ μA		0.05		0	0.05		0.05	V
		V_{DD} = 15V		0.05		0	0.05		0.05	V
V_{OH}	High Level Output Voltage	V_{DD} = 5V	4.95		4.95	5		4.95		V
		V_{DD} = 10V $\|I_O\| < 1$ μA	9.95		9.95	10		9.95		V
		V_{DD} = 15V	14.95		14.95	15		14.95		V
V_{IL}	Low Level Input Voltage	V_{DD} = 5V, V_O = 0.5V or 4.5V		1.5		2	1.5		1.5	V
		V_{DD} = 10V, V_O = 1.0V or 9.0V		3.0		4	3.0		3.0	V
		V_{DD} = 15V, V_O = 1.5V or 13.5V		4.0		6	4.0		4.0	V
V_{IH}	High Level Input Voltage	V_{DD} = 5V, V_O = 0.5V or 4.5V	3.5		3.5	3		3.5		V
		V_{DD} = 10V, V_O = 1.0V or 9.0V	7.0		7.0	6		7.0		V
		V_{DD} = 15V, V_O = 1.5V or 13.5V	11.0		11.0	9		11.0		V
I_{OL}	Low Level Output Current (Note 3)	V_{DD} = 5V, V_O = 0.4V	2.85		2.27	3.6		1.6		mA
		V_{DD} = 10V, V_O = 0.5V	4.96		4.0	9.0		2.8		mA
		V_{DD} = 15V, V_O = 1.5V	19.3		15.6	34.0		10.9		mA
I_{OH}	High Level Output Current (Note 3)	V_{DD} = 5V, V_O = 2.5V	7.96		6.42	13.0		4.49		mA
		V_{DD} = 10V, V_O = 9.5V	4.19		3.38	8.0		2.37		mA
		V_{DD} = 15V, V_O = 3.5V	16.3		13.2	30.0		9.24		mA
I_{IN}	Input Current	V_{DD} = 15V, V_{IN} = 0V		−0.10		-10^{-5}	−0.10		−1.0	μA
		V_{DD} = 15V, V_{IN} = 15V		0.10		10^{-5}	0.10		1.0	μA

DC Electrical Characteristics (Note 2)—CD4541BC

Symbol	Parameter	Conditions	−40°C		+25°C			+85°C		Units
			Min	Max	Min	Typ	Max	Min	Max	
I_{DD}	Quiescent Device Current	V_{DD} = 5V, V_{IN} = V_{DD} or V_{SS}		20		0.005	20		150	μA
		V_{DD} = 10V, V_{IN} = V_{DD} or V_{SS}		40		0.010	40		300	μA
		V_{DD} = 15V, V_{IN} = V_{DD} or V_{SS}		80		0.015	80		600	μA
V_{OL}	Low Level Output Voltage	V_{DD} = 5V		0.05		0	0.05		0.05	V
		V_{DD} = 10V $\|I_O\| < 1$μA		0.05		0	0.05		0.05	V
		V_{DD} = 15V		0.05		0	0.05		0.05	V
V_{OH}	High Level Output Voltage	V_{DD} = 5V	4.95		4.95	5		4.95		V
		V_{DD} = 10V $\|I_O\| < 1$ μA	9.95		9.95	10		9.95		V
		V_{DD} = 15V	14.95		14.95	15		14.95		V
V_{IL}	Low Level Input Voltage	V_{DD} = 5V, V_O = 0.5V or 4.5V		1.5		2	1.5		1.5	V
		V_{DD} = 10V, V_O = 1.0V or 9.0V		3.0		4	3.0		3.0	V
		V_{DD} = 15V, V_O = 1.5V or 13.5V		4.0		6	4.0		4.0	V

DC Electrical Characteristics (Note 2)—CD4541BC (Continued)

Symbol	Parameter	Conditions	−40°C		+25°C			+85°C		Units
			Min	Max	Min	Typ	Max	Min	Max	
V_{IH}	High Level Input Voltage	V_{DD} = 5V, V_O = 0.5V or 4.5V	3.5		3.5	3		3.5		V
		V_{DD} = 10V, V_O = 1.0V or 9.0V	7.0		7.0	6		7.0		V
		V_{DD} = 15V, V_O = 1.5V or 13.5V	11.0		11.0	9		11.0		V
I_{OL}	Low Level Output Current (Note 3)	V_{DD} = 5V, V_O = 0.4V	2.32		1.96	3.6		1.6		mA
		V_{DD} = 10V, V_O = 0.5V	3.18		2.66	9.0		2.18		mA
		V_{DD} = 15V, V_O = 1.5V	12.4		10.4	34.0		8.50		mA
I_{OH}	High Level Output Current (Note 3)	V_{DD} = 5V, V_O = 2.5V	5.1		4.27	130		3.5		mA
		V_{DD} = 10V, V_O = 9.5V	2.69		2.25	8.0		1.85		mA
		V_{DD} = 15V, V_O = 13.5V	10.5		8.8	30.0		7.22		mA
I_{IN}	Input Current	V_{DD} = 15V, V_{IN} = 0V		−0.3		-10^{-5}	−0.3		−1.0	μA
		V_{DD} = 15V, V_{IN} = 15V		0.3		10^{-5}	0.3		1.0	μA

AC Electrical Characteristics* T_A = 25°C, C_L = 50 pF (refer to test circuits)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
t_{TLH}	Output Rise Time	V_{DD} = 5V		50	200	ns
		V_{DD} = 10V		30	100	ns
		V_{DD} = 15V		25	80	ns
t_{THL}	Output Fall Time	V_{DD} = 5V		50	200	ns
		V_{DD} = 10V		30	100	ns
		V_{DD} = 15V		25	80	ns
t_{PLH}, t_{PHL}	Turn-Off, Turn-On Propagation Delay, Clock to Q (2^8 Output)	V_{DD} = 5V		1.8	4.0	μs
		V_{DD} = 10V		0.6	1.5	μs
		V_{DD} = 15V		0.4	1.0	μs
t_{PHL}, t_{PLH}	Turn-On, Turn-Off Propagation Delay, Clock to Q (2^{16} Output)	V_{DD} = 5V		3.2	8.0	μs
		V_{DD} = 10V		1.5	3.0	μs
		V_{DD} = 15V		1.0	2.0	μs
$t_{WH(CL)}$	Clock Pulse Width	V_{DD} = 5V	400	200		ns
		V_{DD} = 10V	200	100		ns
		V_{DD} = 15V	150	70		ns
f_{CL}	Clock Pulse Frequency	V_{DD} = 5V		2.5	1.0	MHz
		V_{DD} = 10V		6.0	3.0	MHz
		V_{DD} = 15V		8.5	4.0	MHz
$t_{WH(R)}$	MR Pulse Width	V_{DD} = 5V	400	170		ns
		V_{DD} = 10V	200	75		ns
		V_{DD} = 15V	150	50		ns
C_I	Average Input Capacitance	Any Input		5.0	7.5	pF
C_{PD}	Power Dissipation Capacitance (Note 4)			100		pF

*AC Parameters are guaranteed by DC correlated testing.

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: V_{SS} = 0V unless otherwise specified.

Note 3: I_{OH} and I_{OL} are tested one output at a time.

Note 4: C_{PD} determines the no load AC power consumption of any CMOS device. For complete explanation, see 54C/74C family characteristics application note AN-90.

Truth Table

Pin	State	
	0	1
5	Auto Reset Operating	Auto Reset Disabled
6	Timer Operational	Master Reset On
9	Output Initially Low after Reset	Output Initially High after Reset
10	Single Cycle Mode	Recycle Mode

Division Ratio Table

A	B	Number of Counter Stages n	Count 2^n
0	0	13	8192
0	1	10	1024
1	0	8	256
1	1	16	65536

Operating Characteristics

With Auto Reset pin set to a ''0'' the counter circuit is initialized by turning on power. Or with power already on, the counter circuit is reset when the Master Reset pin is set to a ''1''. Both types of reset will result in synchronously resetting all counter stages independent of counter state.

The RC oscillator frequency is determined by the external RC network, i.e.:

$$f = \frac{1}{2.3\ R_{tc}C_{tc}} \text{ if } (1\ kHz \leq f \leq 100\ kHz)$$

and $R_S \approx 2\ R_{tc}$ where $R_S \geq 10\ k\Omega$

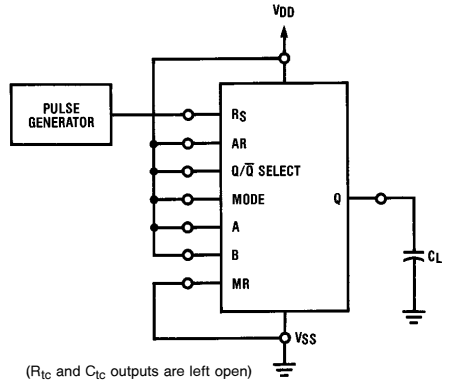
The time select inputs (A and B) provide a two-bit address to output any one of four counter stages (2^8, 2^{10}, 2^{13}, and 2^{16}). The 2^n counts as shown in the Division Ratio Table represent the Q output of the Nth stage of the counter. When A is ''1'', 2^{16} is selected for both states of B.

However, when B is ''0'', normal counting is interrupted and the 9th counter stage receives its clock directly from the oscillator (i.e., effectively outputting 2^8).

The Q/$\overline{Q}$ select output control pin provides for a choice of output level. When the counter is in a reset condition and Q/$\overline{Q}$ select pin is set to a ''0'' the Q output is a ''0''. Correspondingly, when Q/$\overline{Q}$ select pin is set to a ''1'' the Q output is a ''1''.

When the mode control pin is set to a ''1'', the selected count is continually transmitted to the output. But, with mode pin ''0'' and after a reset condition the RS flip-flop resets (see Logic Diagram), counting commences and after 2^{n-1} counts the RS flip-flop sets which causes the output to change state. Hence, after another 2^{n-1} counts the output will not change. Thus, a Master Reset pulse must be applied or a change in the mode pin level is required to reset the single cycle operation.

Power Dissipation Test Circuit and Waveforms



(R_{tc} and C_{tc} outputs are left open)

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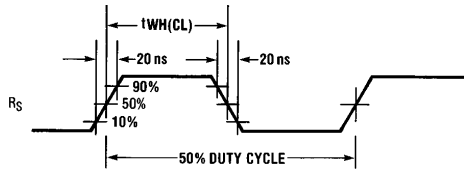

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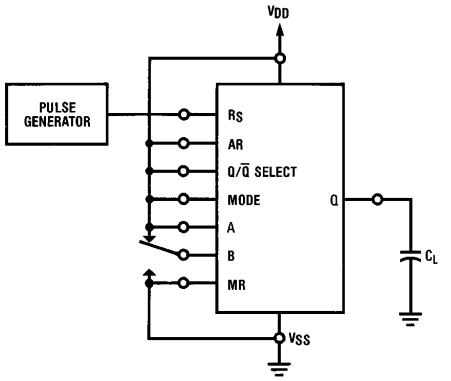
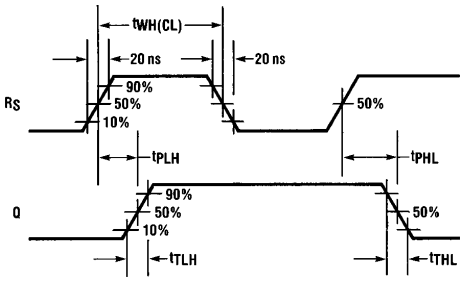
Switching Time Test Circuit and Waveforms



TL/F/6001–4



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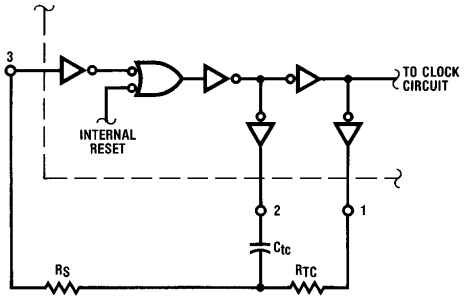
Operating Characteristics (Continued)

Oscillator Circuit Using RC Configuration



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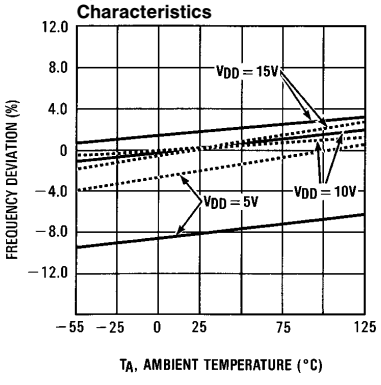
Typical RC Oscillator Characteristics



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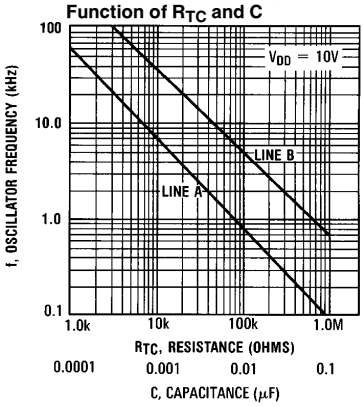
Solid Line = R_{TC} = 56 kΩ, R_S = 1 kΩ and C = 1000 pF
f = 10.2 kHz @ V_{DD} = 10V and T_A = 25°C

Dashed Line = R_{TC} = 56 kΩ, R_S = 120 kΩ and C = 1000 pF
f = 7.75 kHz @ V_{DD} = 10V and T_A = 25°C

RC Oscillator Frequency as a Function of R_{TC} and C



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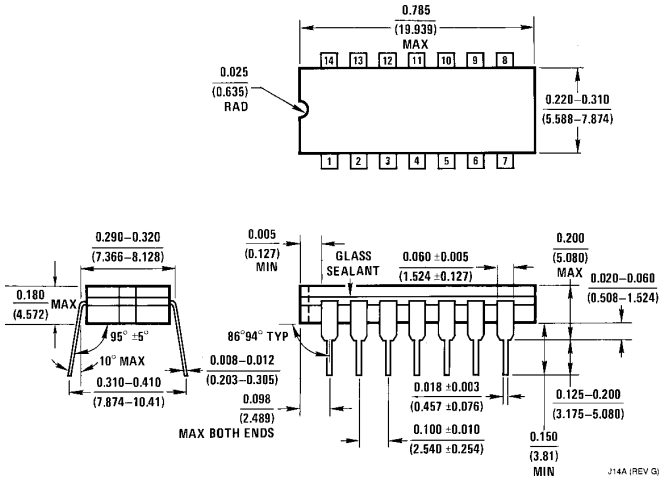
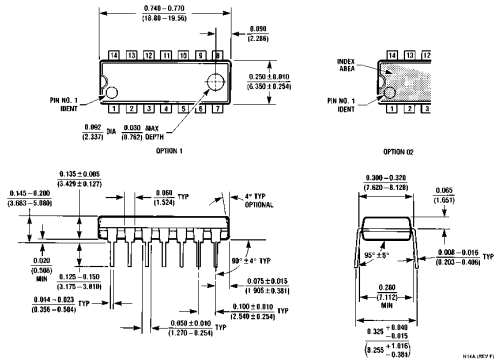
Line A: f as a function of C and (R_{TC} = 56 kΩ; R_S = 120k)

Line B: f as a function of R_{TC} and (C = 100 pF; R_S = 2 R_{TC})

Physical Dimensions inches (millimeters)



Ceramic Dual-In-Line Package (J)
Order Number CD4541BMJ or CD4541BCJ
NS Package Number J14A



Molded Dual-In-Line Package (N)
Order Number CD4541BMN or CD4541BCN
NS Package Number N14A

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National Semiconductor Corporation
1111 West Bardin Road
Arlington, TX 76017
Tel: 1(800) 272-9959
Fax: 1(800) 737-7018

National Semiconductor Europe
Fax: (+49) 0-180-530 85 86
Email: cnjwge@tevm2.nsc.com
Deutsch Tel: (+49) 0-180-530 85 85
English Tel: (+49) 0-180-532 78 32
Français Tel: (+49) 0-180-532 93 58
Italiano Tel: (+49) 0-180-534 16 80

National Semiconductor Hong Kong Ltd.
13th Floor, Straight Block,
Ocean Centre, 5 Canton Rd.
Tsimshatsui, Kowloon
Hong Kong
Tel: (852) 2737-1600
Fax: (852) 2736-9960

National Semiconductor Japan Ltd.
Tel: 81-043-299-2309
Fax: 81-043-299-2408